

### **SPECIFICATIONS**

CUSTOMER . Geneva Lab Information Consulting

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MASS PRODUCTION CODE . PH128160T-066-L01Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) . JLMD-PH128160T-066-L01Q \_001

PACKAGING NO. (Ver.) . JPKG-PH128160T-066-L01Q \_001

## **Customer Approved**

Date:

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☐ Preliminary specification for design input

Specification for sample approval

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# **History of Version**

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2/15/2011	01	001	New Drawing	-	Violin Huang
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				<b>-</b>	

Total: 23 Pages



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### 1. SPECIFICATIONS

### 1.1 Features

### **Main LCD Panel**

Item	Standard Value		
Display Type	128 *3(R · G · B) * 160 Dots		
LCD Type	a-Si TFT , Normally White TN mode , Transmissive		
Screen size(inch)	1.77 (Diagonal)		
Viewing Direction	12 O'clock		
Color configuration	R.G.B. vertical stripe		
Backlight	White LED		
Interface	4-line SPI interface		
Other(controller / driver IC)	ST7735R( Support 65K or 262K Colors )		
	THIS PRODUCT CONFORMS THE ROHS OF PTC		
ROHS	Detail information please refer web side :		
	http://www.powertip.com.tw/news/LatestNews.asp		

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	34.0 (W) * 47.0 (L) * 2.4 (H)(MAX)	mm

### **TFT LCD Panel**

Item	Standard Value			
Viewing Area (LCD)	29.032 (W) * 36.04 (L)	mm		
Active Area (LCD)	28.032 (W) * 35.04 (L)	mm		

Note: For detailed information please refer to LCM drawing.



## 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	1	-0.3	+4.6	V
	/VGH-VGL/	-	-0.3	30.0	V
Input Voltage	VIN	-	-0.3	VDD+0.3	V
Operating Temperature	T <sub>OP</sub>	-	-20	+70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	+80	°C
Storage Humidity	H <sub>D</sub>	Ta ≤ 60 °C	20	90	%RH

### 1.4 DC Electrical Characteristics

Module GND = 0V, Ta =  $25^{\circ}C$ 

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Interface operation voltage	VDD	I/O supply voltage	-	2.8	3.0	٧
Input High Voltage	$V_{IH}$	-	0.7*VDD	ı	VDD	V
Input Low Voltage	V <sub>IL</sub>	-	GND	-	0.3*VDD	V
Output High Voltage	V <sub>OH</sub>	IOH=-0.1mA	0.8*VDD	-	VDD	٧
Output Low Voltage	V <sub>OL</sub>	IOL=0.1mA	GND	ı	0.2*VDD	V
Supply Current	IDD	VDD= 2.8V, Pattern= Black*1	1	1.0	1.5	mA

Note1 : Maximum current display.



### 1.5 Optical Characteristics

#### **TFT LCD Panel**

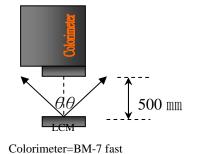
VDD = 2.8V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response time		Tr + Tf	Ta = 25°C θX, θY = 0°	-	40	60	ms	Note2
	Тор	θΥ+		ı	30	-		
Viewing angle	Bottom	θY-	CR ≥ 10	-	15	-	Deg.	Note4
viewing angle	Left	θX-	CIX 2 10	-	45	-	Deg.	Note4
	Right	θX+	<u>1                                    </u>	-	45	-		
Contrast ratio	0	CR		150	200	-	-	Note3
	White	X	Ta = 25°C θX , θY = 0°	0.25	0.30	0.35	-	
	VVIIILE	Y		0.27	0.32	0.37		
0 1 10=	Red	Х		0.59	0.64	0.69		
Color of CIE Coordinate		Υ		0.29	0.34	0.39		Note1
(With B/L)	Green	X	0,01-0	0.29	0.34	0.39		Note
,	Green	Υ		0.55	0.60	0.65		
	Blue	X		0.09	0.14	0.19		
	Diue	Υ		0.03	0.08	0.13	1	
Average Brightness								
Pattern=white display		IV	IF= 30mA	250	300	-	cd/m <sup>2</sup>	Note1
(With B/L)								

#### Note1:

- $1 : \triangle B = B(min) / B(max) \times 100\%$ .
- 2: Measurement Condition for Optical Characteristics:
  - a : Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50$  mm,  $(\theta = 0^{\circ})$ .
  - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%.



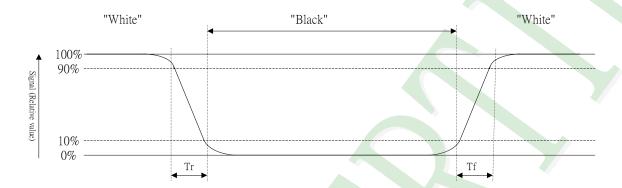




#### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

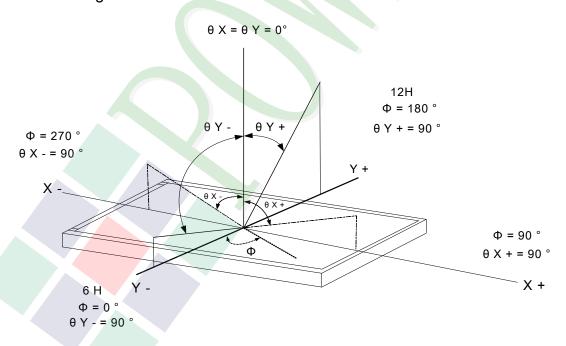
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





## 1.6 Backlight Characteristics

Maximum Ratings With one LED

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°ℂ	-	35	mA
Reverse Voltage	VR	Ta =25°ℂ	-	5	V
Forward Voltage	VF	Ta =25°C	-	3.5	V
Power Dissipation	PD	Ta =25°ℂ		123	mW

Electrical / Optical Characteristics

Electrical / Optical orial acteristics						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=30mA	-	3.2	3.5	V
Average Brightness (without LCD)	IV	IF=30mA	3200	3500	-	cd/m <sup>2</sup>
Color of CIE Coordinate	X	IF-30IIIA	-	0.30	ı	
(without LCD)	Y		-	0.29	ı	1
Color			White			

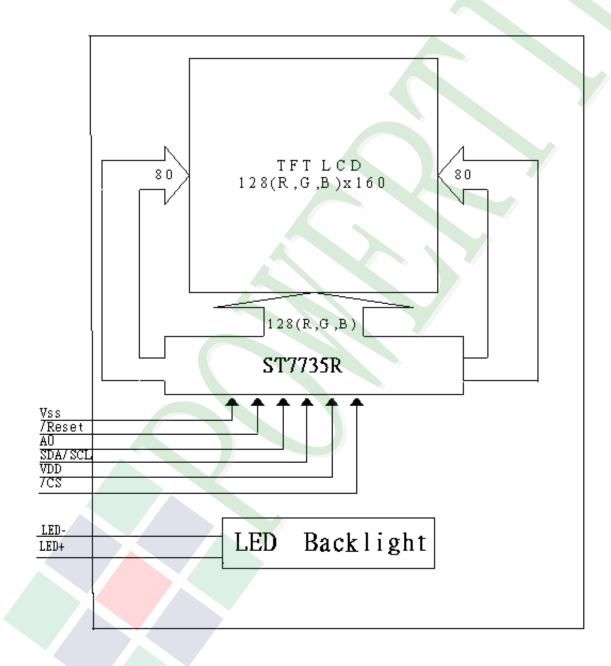




## 2. MODULE STRUCTURE

## 2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
  - \* See Appendix
- 2.1.2 Block Diagram





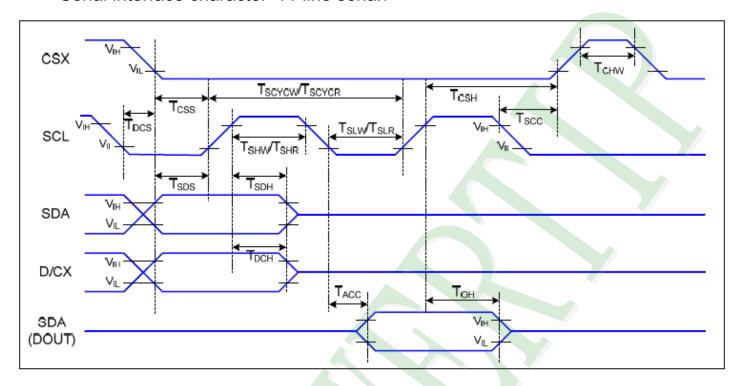
# 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	NC	No Connection
2	VSS	Ground
3	LED-	LED Cathode
4	LED+	LED Anode
5	VSS	ground
6	/RESET	System Reset Pin
7	A0	Register select signal pin. L :Command; H:Display Data
8	SDA	Serial data input
9	SCL	Serial clock input
10	VDD	Power Supply
11	VDDI	Power Supply
12	/CS	Chip select input pin
13	VSS	Ground
14	NC	No Connection



## 2.3 Timing Characteristics

Serial interface character (4-line serial)

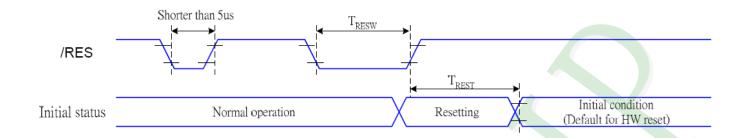


Ta=25 °C, VDDI=1.65~3.7V, VDD=2.3~4.8V

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	TCSS	Chip select setup time (write)	45		ns	
	TCSH	Chip select hold time (write)	45		ns	
CSX	TCSS	Chip select setup time (read)	60		ns	
	TSCC	Chip select hold time (read)	65		ns	
	TCHW	Chip select "H" pulse width	40		ns	
	TSCYCW	Serial clock cycle (Write)	66		ns	-write command & data
	TSHW	SCL "H" pulse width (Write)	15		ns	ram
SCL	TSLW	SCL "L" pulse width (Write)	15		ns	Talli
SOL	TSCYCR	Serial clock cycle (Read)	150		ns	-read command & data
	TSHR	SCL "H" pulse width (Read)	60		ns	ram
	TSLR	SCL "L" pulse width (Read)	60		ns	Talli
D/CX	TDCS	D/CX setup time	10		ns	
DICX	TDCH	D/CX hold time	10		ns	
CDA	TSDS	Data setup time	10		ns	
SDA	TSDH	Data hold time	10		ns	For maximum CL=30pF
(DIN) (DOUT)	TACC	Access time	10	50	ns	For minimum CL=8pF
(5001)	TOH	Output disable time	15	50	ns	



## Reset Timing:



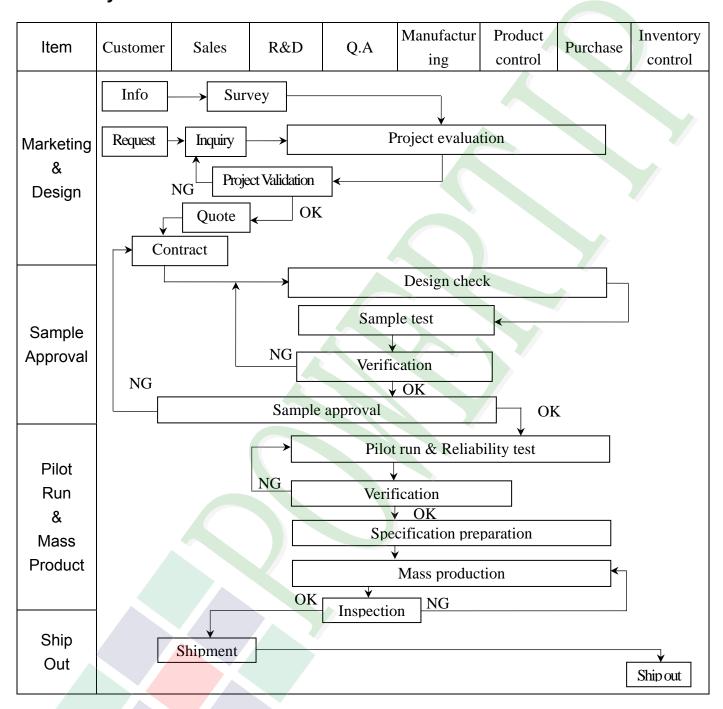
Related Pins	Symbol	Parameter	MIN	MAX	Unit
	tRESW	Reset pulse duration	10	-	us
/RES	tREST Reset cancel	Poset cancel	-	5	ms
			120	ms	



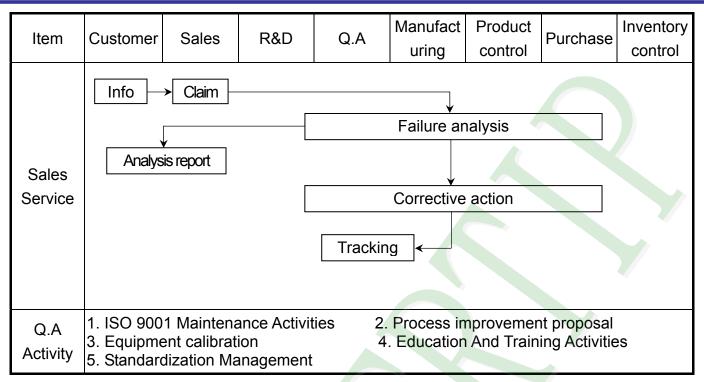


## 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart









### 3.2. Inspection Specification

**♦**Scope : The document shall be applied to TFT-LCD Module for less than 3, 5" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge、MIL-STD、Powertip Tester、Sample

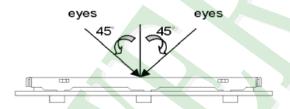
◆Defect Level: Major Defect AQL: 0,4; Minor Defect AQL: 1,5

◆OUT Going Defect Level: Sampling.

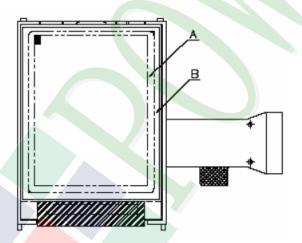
◆Standard of the product appearance test:

#### a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



## ♦ Specification For TFT-LCD Module Less Than 3.5'':

NO	Item			Criteri	ion	Level
	Product condition	1. 1The part number is inconsistent with work order of production.				
01		1. 2 Mixed product types.				
			sembled	in inverse direction		Major
02	Quantity	2. 1Th	e quantit	y is inconsistent wit	h work order of production.	Major
03	Outline dimension		3. 1 Product dimension and structure must conform to structure diagram.			
		4. 1 Mi	issing lin	e character and ico	n.	Major
		4, 2 No function or no display.				
04	Electrical Testing	4. 3 Display malfunction.				
		4. 4 LCD viewing angle defect.				
		4. 5 Cu	irrent co	nsumption exceeds	product specifications.	Major
				Item	Acceptance (Q'ty)	
	Dot defect			Bright Dot	≦ 2	
	Dot defect		Dot	Dark Dot	≦ 3	
٥٦	(Bright dot \		Defect	Joint Dot	≦ 2	
05	Dark dot)			Total	≦ 3	Minor
	On -display	5. 1 Inspection pattern: full white, full black, Red, Green and				
				blue scree	ns.	
		5. 2 It is defined as dot defect if defect area $>1/2$ dot.				
		5. 3 Th	e distanc	ce between two dot	defect ≧5 mm.	



## igspace Specification For TFT-LCD Module Less Than 3.5":

NO	Item	Criterion					Level
		6. 1 Round typ	e ( Non-display	or dis	splay):		
			Dimension (diameter : Φ)		Acceptance (Q'ty)		
	Disals an archite	(dia			A area	B area	
	Black or white dot \ scratch \		$\Phi \leq 0.15$		Ignore		
	contamination	0.15	$<\Phi \le 0.20$		2		
	Round type	0.20	$<\Phi \le 0.30$		2	Ignore	
	→ x ← ↓		$\Phi > 0.30$		0		
06	Y Y		Total		3		Minor
	$\Phi = (x+y)/2$	6. 2 Line type(	r display) :				
	Line type	Dimension			Acceptance (Q'ty)		
		Length (L)	Width (W	<b>/</b> )	A area	B area	
			W≦	0.03	Ignore		
		$L \le 5.0$ $0.03 < W \le 0.03$		0.05			
			w >	0.05	As round type	Ignore	
			Total		3		
			ension ieter : Ф)	Acceptance (			
				A area		B area	
07	Polarizer		Φ ≤ 0.20		gnore		Minan
01	Bubble	Bubble $0.20 < \Phi \le 0.50$ $\Phi > 0.50$		3		Ignore	Minor
				0		15.010	
		Т	otal		3		



## ◆Specification For TFT-LCD Module Less Than 3.5":

NO	Item	Criterion		Level
		Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and cra	nck between panels:	
08	The crack of glass	SP Y [OK]	SP [NG]	Minor
		Seal width	Y	
		X Y	z	
		≤ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	
4				



## ◆Specification For TFT-LCD Module Less Than 3.5″:

NO	Item	Criterion	Level					
	Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 1. 2 Corner crack:							
		$egin{array}{c cccc} X & Y & Z & & & & & & & & & & & & & & \\ & & & &$						
08	The crack of glass	$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z $\leq 2$ t	Minor					
		8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad:						
		X X Z X Z Z						
		W X						
		$\begin{array}{c cccc} X & Y & Z \\ \hline Front & \leq a & \leq 1/2  W & \leq t \end{array}$						
		Back $\leq a$ $\leq W$ $\leq 1/2 t$						



# ◆Specification For TFT-LCD Module Less Than 3.5″:

Symbols:  X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length	
8. 2. 2 Non-conductive portion:    W	Minor



## $\spadesuit$ Specification For TFT-LCD Module Less Than 3. 5" :

NO	Item	Criterion	Level	
	Backlight elements	9. 1 Backlight can't work normally.	Major	
09				Major
		9. 3 Illumination source flickers when lit.	Major	
		10. 1 Pin type · quantity · dimension must match type in structure diagram.	Major	
		10. 2 No short circuits in components on PCB or FPC .	Major	
10	General	10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major	
10	арреагапсе	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor	
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor	
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is $\leq 1.5$ mm.	Minor	



## 4. RELIABILITY TEST

4.1 Reliability Test Condition

	(VCI.DOT)						
NO.	TEST ITEM	TEST CONDITION					
1	High Temperature	Keep in +80°C ±2°C 96 hrs					
1	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.					
2	Low Temperature	Keep in −30°C ±2°C 96 hrs					
7	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.					
	High Temperature /	Keep in $+60^{\circ}$ C / $90^{\circ}$ R.H duratio	n for 96 hrs				
3	High Humidity Storage Test	Surrounding temperature, then st	orage at normal condition 4hrs.				
		(Excluding the polarizer)					
		-30°C → +25°C	$\rightarrow$ +80°C $\rightarrow$ +25°C				
4	<b>Temperature Cycling</b>	(30mins) (5mins)	(30mins) (5mins)				
*	Storage Test	10	Cycle				
		Surrounding temperature, then st	orage at normal condition 4hrs.				
	ESD Test	Air Discharge:	Contact Discharge:				
		Apply 2 KV with 5 times	Apply 250 V with 5 times				
		Discharge for each polarity +/-	discharge for each polarity +/-				
		1. Temperature ambiance : $15^{\circ}$ C $\sim 35^{\circ}$ C					
5		2. Humidity relative : 30%~60%					
		3. Energy Storage Capacitance(Cs+Cd): 150pF±10%					
		4. Discharge Resistance(Rd): $330 \Omega \pm 10\%$					
		5. Discharge, mode of operation :					
			successive discharges at least 1 sec)				
		(Tolerance if the output voltage indication: ±5%)					
	Vibration Test	1. Sine wave 10~55 Hz frequence	cy (1 min/sweep)				
6	(Packaged)	2. The amplitude of vibration :1.5 mm					
	(2 menangem)	3. Each direction (X \ Y \ Z) duration for 2 Hrs					
		Packing Weight (Kg	) Drop Height (cm)				
		0 ~ 45.4	122				
	Drop Test	45.4 ~ 90.8	76				
7	(Packaged)	90.8 ~ 454	61				
		Over 454	46				
		Dran Direction : %1 corner / 2 ada	ras / 6 sidos anab 1tima				
	Drop Direction: **1 corner / 3 edges / 6 sides each 1time						



### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

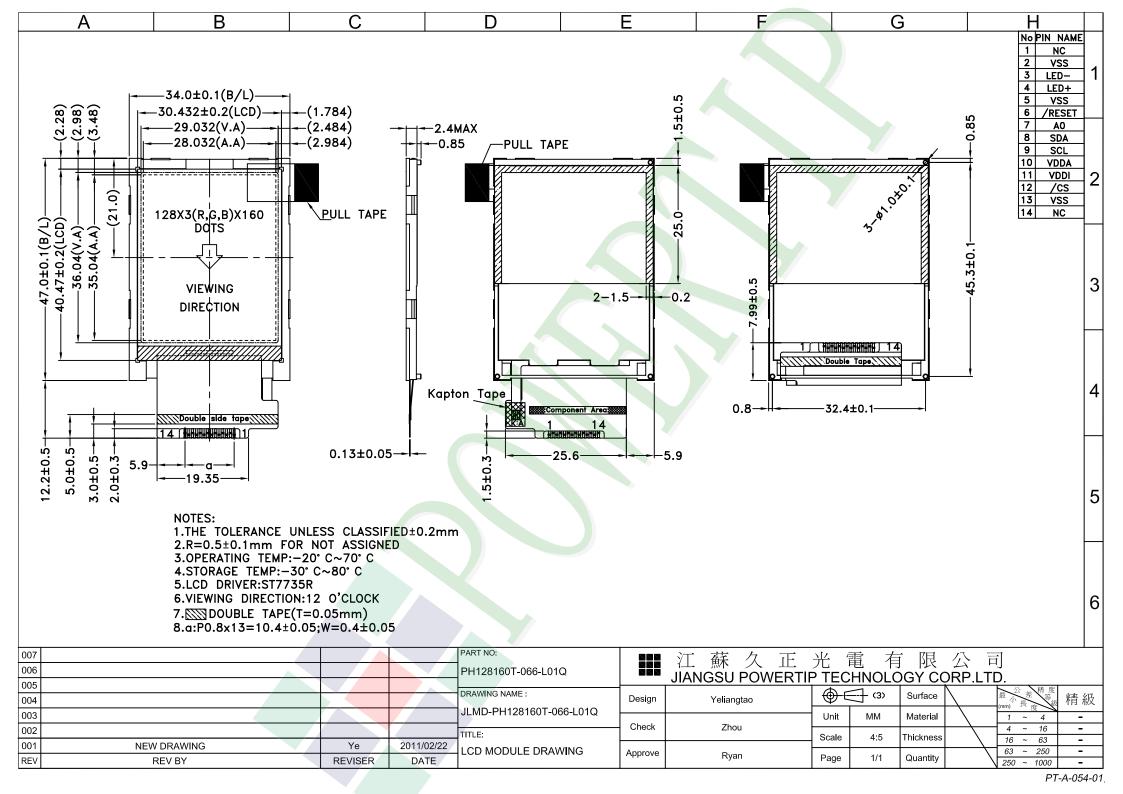
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### **5.4 TERMS OF WARRANTY**

- 5.4.1 Applicable warrant period
  - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
  - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



				Г	Approve	Check	Contact
Ver.	001	_ LCM包	裝規格書	-	TAPPIONE	CHECK	Contact
Documents NO. JPKG-PH128160T-066-L01Q LCM Packaging Specifications					Ryan	Ryan	Ye
	·		r Tray)				
1.包	L裝材料規格表 (Packaging Materi	al): (per carton)					
No.	Item	Model	Dimensions (mm)	1Pcs	Weight	Quantity	Total Weight
1	72 1111 ( )	H128160T-066-L01Q	34.0 X 47.0	6	.0	864	5.18
2		TFILM0BA03ABA	19"X350X0.015	_	_	6	
3		YPH12816044BH	352 X 260 X 10.8		00	60	6.0
4	/ロイロ☆にはくハウ 1 1 1 1	X36627063ABBA	393 X 274 X 68		2692	6	1.6152
5	LI ATAKIN O	TPLB00PL08ABA	550 X 393 X 20		)284 4208	2	0.0568 1.4208
7	公子去(四)	X57041027CCBA	570 X 410 X 265 310 X 225 X 1		1208	54	0.027
8		TFOAMPHD05ABA	310 A 223 A 1	0.0	,,,,,	31	0.027
9							
	整箱總重量 (Total LCD Weight in ca		0% 取小數2位				
	箱數量規格表 (Packaging Specification)		v ma of t	^		_ 144	
	CM quantity per box : no per tray otal LCM quantity in carton : quantity ;	16 per box 144	x no of tray x no of boxes	9		= 144 = 864	
	+ roducts into the tray  (2)TRA  Tray  stacking	(3)內盒 Product Box	Ca	靠板 / ward		Wertip	
MODE LOT 1	NO:	特記事 A A A A A A A A A A A B B B B B B B B B B B B B	and place on top of stack.	It's	適用於單。 also suital	品包裝 ble to Panel	